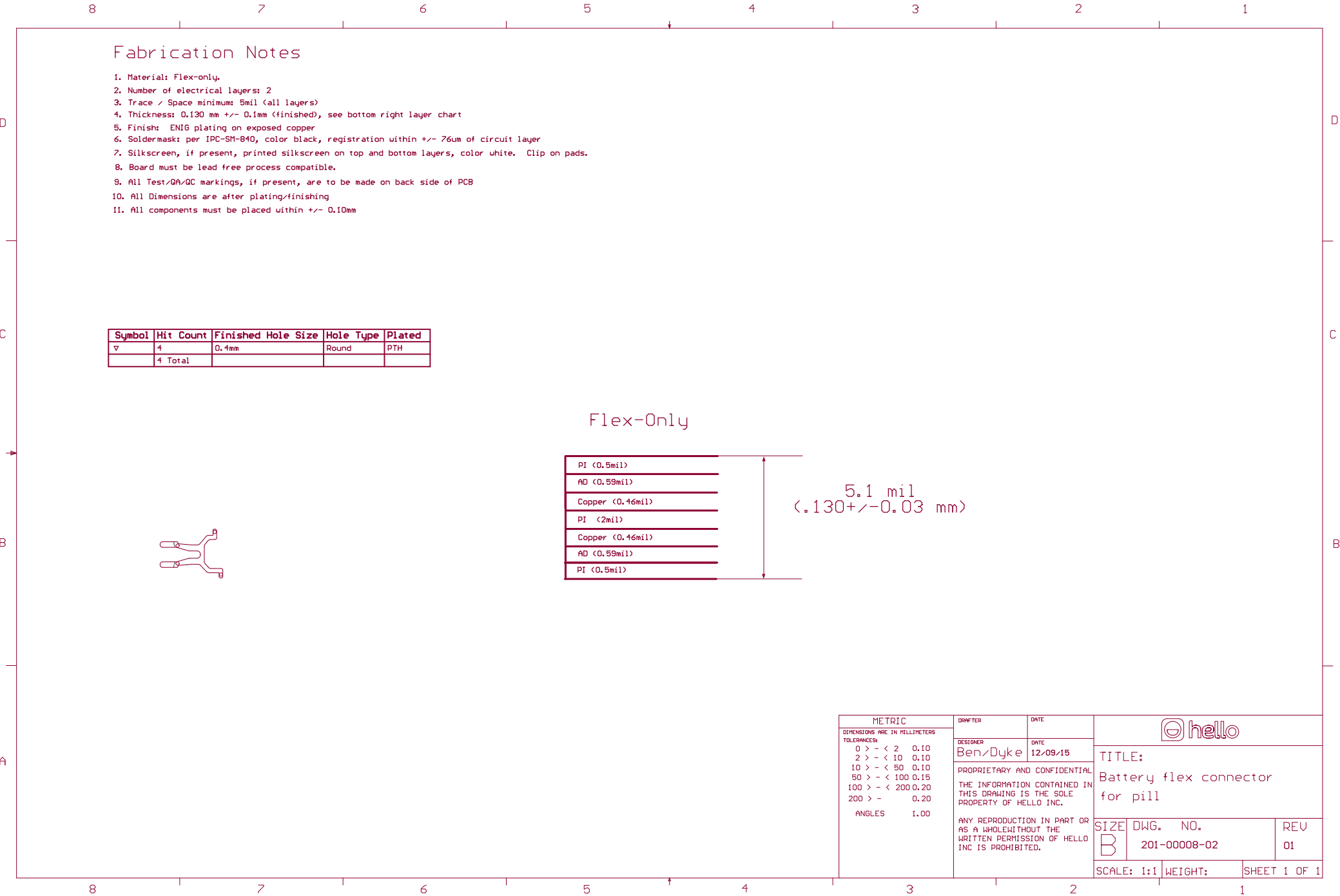


Board outline



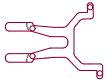
Fabrication Notes

1. Material: Flex-only.
2. Number of electrical layers: 2
3. Trace / Space minimum: 5mil (all layers)
4. Thickness: 0.130 mm +/- 0.1mm (finished), see bottom right layer chart
5. Finish: ENIG plating on exposed copper
6. Soldermask: per IPC-SM-840, color black, registration within +/- 76um of circuit layer
7. Silkscreen, if present, printed silkscreen on top and bottom layers, color white. Clip on pads.
8. Board must be lead free process compatible.
9. All Test/QA/QC markings, if present, are to be made on back side of PCB
10. All Dimensions are after plating/finishing
11. All components must be placed within +/- 0.10mm


Symbol	Hit Count	Finished Hole Size	Hole Type	Plated
v	4	0.4mm	Round	PTH
	4 Total			

Flex-Only

5.1 mil
(.130+/-0.03 mm)



PI (0.5mil)
AD (0.59mil)
Copper (0.46mil)
PI (2mil)
Copper (0.46mil)
AD (0.59mil)
PI (0.5mil)

METRIC		DRAFTER	DATE			
DIMENSIONS ARE IN MILLIMETERS		DESIGNER	DATE			
TOLERANCES		Ben/Dyke	12/09/15	TITLE: Battery flex connector for pill		
0 > - < 2 0.10		PROPRIETARY AND CONFIDENTIAL THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF HELLO INC.				
2 > - < 10 0.10						
10 > - < 50 0.10						
50 > - < 100 0.15						
100 > - < 200 0.20						
200 > - 0.20						
ANGLES 1.00		ANY REPRODUCTION IN PART OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION OF HELLO INC IS PROHIBITED.		SIZE	DWG. NO.	REV
				B	201-00008-02	01
				SCALE: 1:1	WEIGHT:	SHEET 1 OF 1